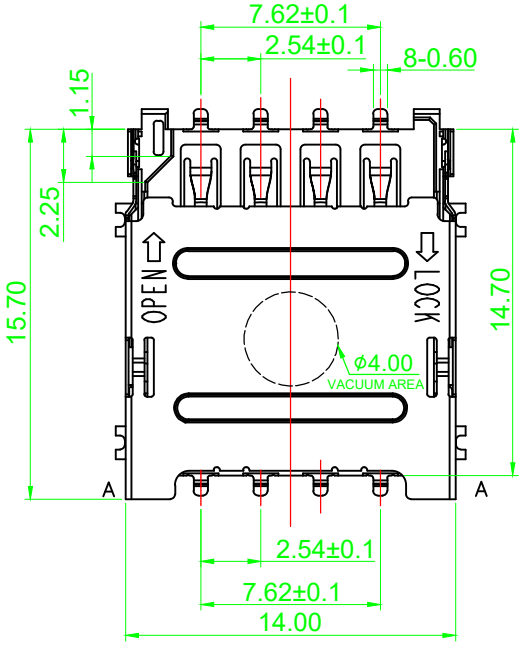
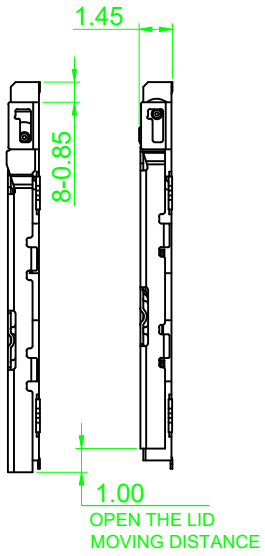
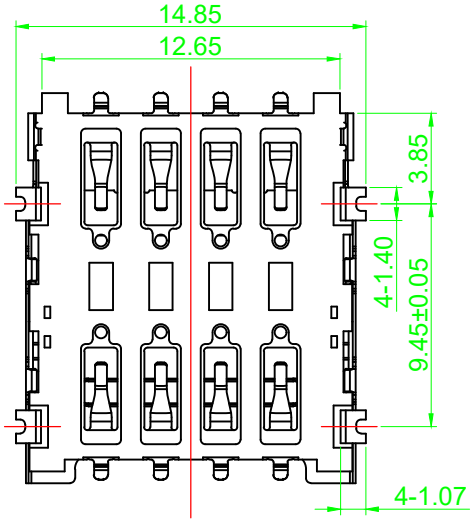
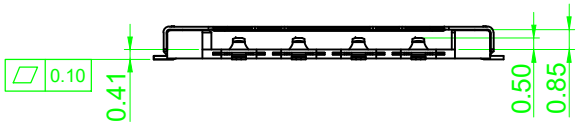


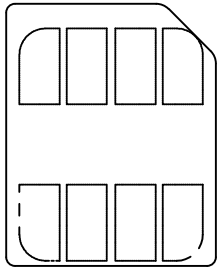






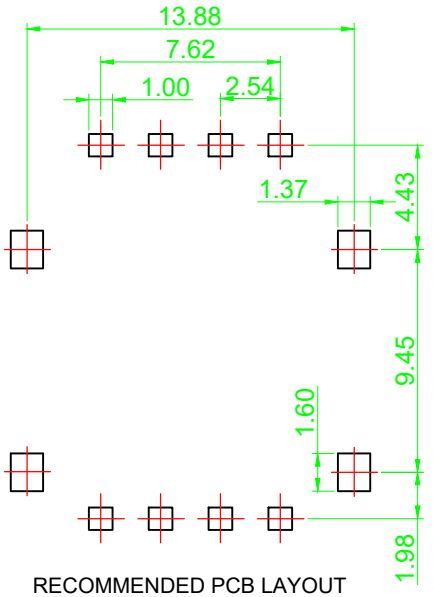


NOTES:
1.MATERIAL:
HOUSING: LCP, UL94V-0, BLACK
CONTACT: COPPER ALLOY T=0.08
HOLDDOWN: SUS304 T=0.15
SHELL: SUS304 T=0.12
2.FINISH:
CONTACT:
CONTACT AREA: 5u" GOLD PLATED
SOLDER AREA: G/F GOLD PLATED
UNDER PLATING: NICKEL PLATED
SHELL:
SOLDER AREA: G/F GOLD PLATED
UNDER PLATING: NICKEL PLATED
HOLDDOWN::
SOLDER AREA: G/F GOLD PLATED
UNDER PLATING: NICKEL PLATED
3.SPECIFICATION:
CURRENT RATING: 0.5A MAX.
VOLTAGE RATING: 10V AC/DC
DIELECTRIC WITHSTANDING: 500V AC FOR 1 MINUTE
CONTACT RESISTANCE: 50mΩ MAX.
INSULATION RESISTANCE: 1000MΩ MIN.
OPERATING TEMPERATURE: -30°C ~ +85°C
DURABILITY: 50 CYCLES MIN.



MICRO SIM CARD

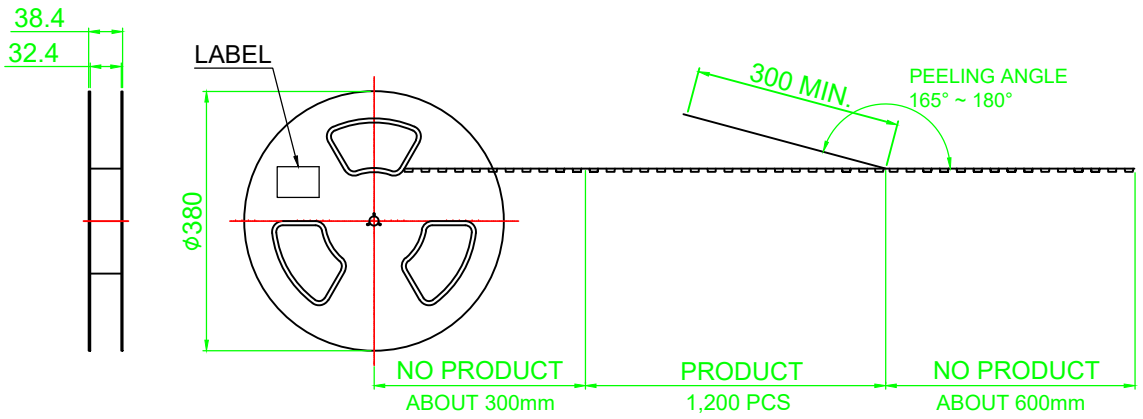
PIN NO.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED



RECOMMENDED PCB LAYOUT

研騰國際企業股份有限公司 YANNIS ELECTRONICS CO.,LTD.	PROJECTION:	UNIT: mm SCALE: Free	GENERAL TOLERANCES: .X ±0.30 X°. ± 3° .XX ±0.20 .X° ± 1° .XXX ±0.10	APPROVED	David	SHEET: 1 OF 2	REV.: A	NAME	Micro SIM Hinge Type 8 Pin H:1.45mm
				CHECKED	Sunny				
				DRAWN	Juno	DATE: 2021/01/26		PART NO.	MSIM-0108082 DWG NO. MSIM-0108082_01

Rev.	Description.	Date	App.
01			



收料方向
GATHER MATERIAL DIRECTION

出料方向
INPUT MATERIAL DIRECTION

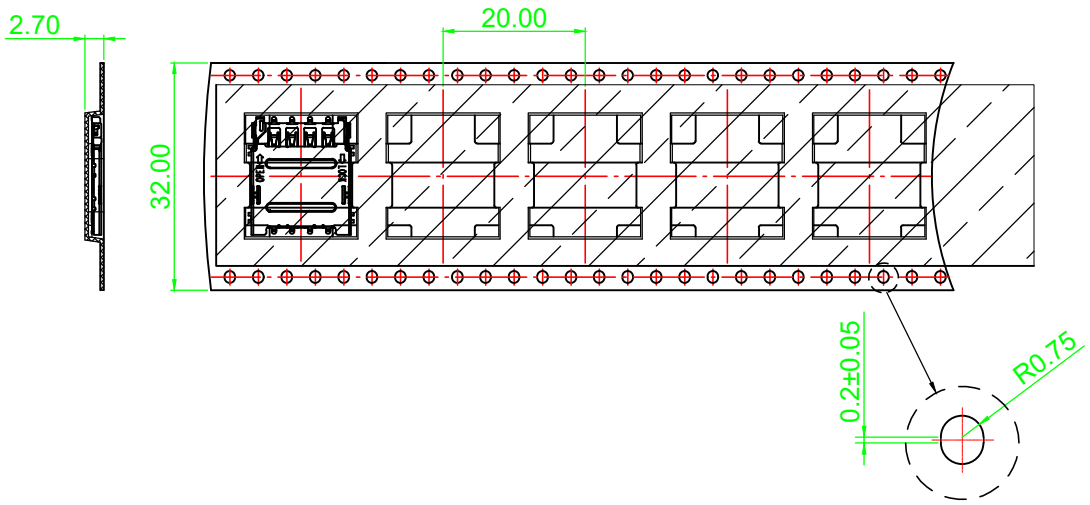
NOTES:

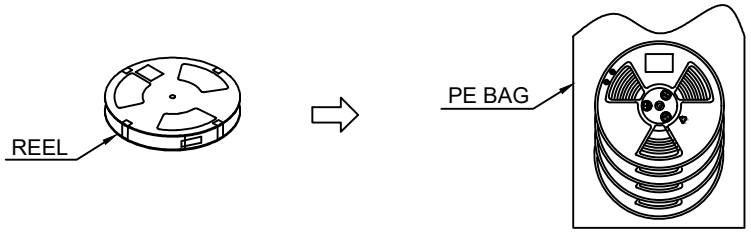
1.PACKING: 1,200 PCS/REEL
12,000 PCS/OUTER CARTON

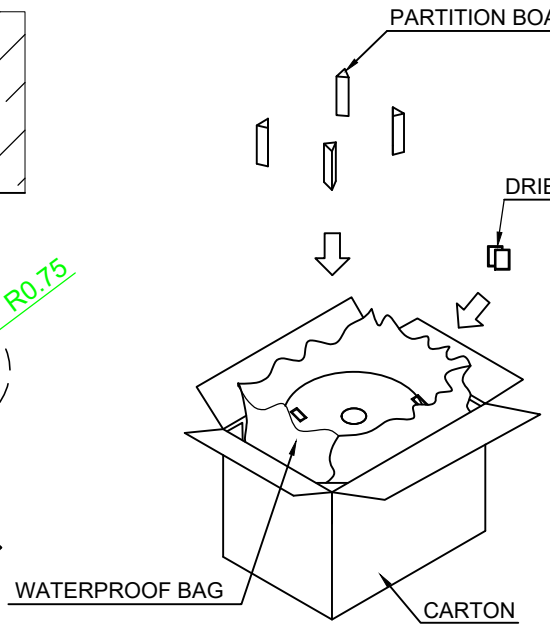
2.MATERIAL: CARRIER TAPE: PS
COVER TAPE: PET FILM
REEL: PLASTIC

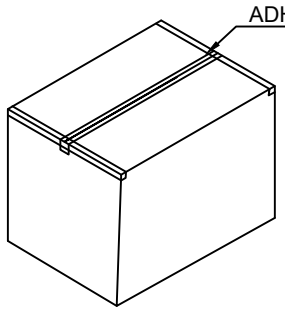
3.PEEL STRENGTH OF COVER TAPE:
20~130g(PEEL SPEED 300mm/MINUTE)

4.G/W: 21.63 Kg , N/W: 0.34 Kg









研騰國際企業股份有限公司 YANNIS ELECTRONICS CO.,LTD.	PROJECTION:	UNIT: mm SCALE: Free	GENERAL TOLERANCES: .X ±0.30 X°. ± 3° .XX ±0.20 .X° ± 1° .XXX ±0.10	APPROVED	David	SHEET: 2 OF 2	REV.: A	NAME	Micro SIM Hinge Type 8 Pin H:1.45mm Packing
				CHECKED	Sunny				
				DRAWN	Juno	DATE: 2021/01/26		PART NO.	MSIM-0108082 DWG NO. MSIM-0108082_01